

DATA SHEET

SUNGMUN CODE : GSMR-16S
DESCRIPTION : MINI ROTARY DIP SWITCH

SUNGMUN ELECTRONICS CO., LTD.

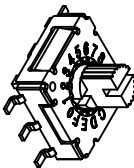
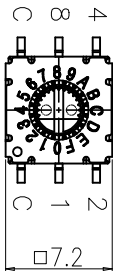
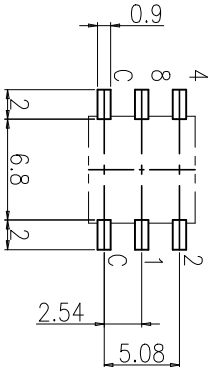
Address 301-302,Bucheon Technopark 345, Seokcheon-ro, Ojeong-gu
Bucheon-si, Gyeonggi-do, Korea
TEL. +82-32-328-1941~4
FAX +82-32-328-1945
E-mail sungmun@sungmun.co.kr
Website www.sungmun.com



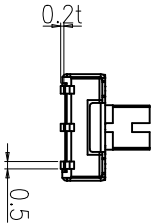
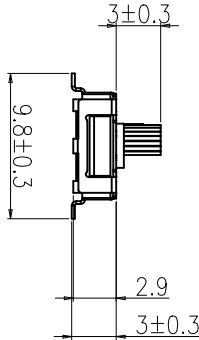
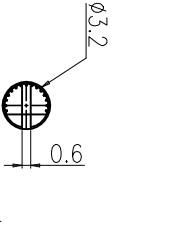
REV. NO.	DATE	REVISION	DR	CH	APP
△	24.12.03	DIN ISO-2768-1m tolerance applied	H.S LEE	K.N KIM	W.J LEE

SPECIFICATION

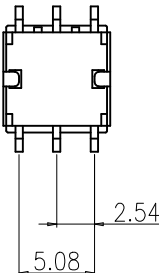
1. Rating : 100mA, DC 5V (Switching)
100mA, DC 50V (None-Switching)
2. Contact Resistance : 100mΩ Max
3. Insulation Resistance : 100MΩ Min at DC 100V
4. Operating Force : 200gf·cm Max
5. Life cycle : 25,000 steps
6. Sealing : IP67 (Dust & Water proof)
7. Packing : 70pcs Tube / 800pcs Reel Packing



P.C.B DIMENSION (Top View)



ACTUATOR



Reel Code								
	C	1	2	4	8			
0	●					0		
1	●	●				1		
2	●		●			2		
3	●		●			3		
4	●			●		4		
5	●	●				5		
6	●		●			6		
7	●	●	●			7		
8	●				●	8		
9	●				●	9		
10	●		●		●	A		
11	●	●			●	B		
12	●			●	●	C		
13	●			●	●	D		
14	●		●		●	E		
15	●	●	●	●	●	F		

△	Din ISO-2768-1m					DRAW/DESIGNED		CHECKED	APPROVED		G.TOL ± D&E/△	TITLE		COMPACT ROTARY DIP SWITCH	
						J.S YANG	W.J LEE	K.I LEE	UNIT			SCALE	MODEL NO.	GSMR-16S	REV.
						2021-11-11	2021-11-11	2021-11-11	mm	N:S	DRAW NO.	GSMR-16S-04	04		
						SUNGUMUN ELECTRONICS CO.,LTD									
Ranges	0.5~3	3~6	6~30	30~120	120~400										
Tolerance	± 0.1	± 0.1	± 0.2	± 0.3	± 0.5										

1. Style:

This specification describes "Compact Mini Rotary Dip Switch" which is G series.

1.1 Operating / Storage Temperature Range : -40°C ~ +85°C

2. Rating:

2.1 None-Switching : 100 mA, DC 50V

2.2 Switching : 100 mA, DC 5V

3. Type of Actuation : Rotating

4. Electrical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
4-1	Visual Examination	By visual examination check without any out pressure & testing.	There shall be no defects that affect the serviceability of the product.
4-2	Contact Resistance	① To be measured between the two terminals associated with each switch pole. ② Measurements shall be made with a 1kHz shall current contact resistance meter.	100mΩ max. (initial)
4-3	Insulation Resistance	100V DC	100 MΩ min.
4-4	Dielectric withstanding Voltage	250V AC(50Hz or 60Hz)shall be applied between all the adjacent terminal and between the terminal and the frame for 1 minute.	There shall be no breakdown or flashover.

5. Mechanical Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
5-1	Operation Force	Operating direction shall be clockwise or counter clockwise direction	200gf•cm max (1.96N•cm max)
5-2	Operation Life	Measurements shall be made following the test set forth below: 1)100mA, 5V DC resistive load 2)Rate of operation: 15~20 cycles/ minute 3)Step of operation: 10,000 steps	1)As shown in item 3,4 2)Contact Resistance: 200mΩ max 3)Final-after test

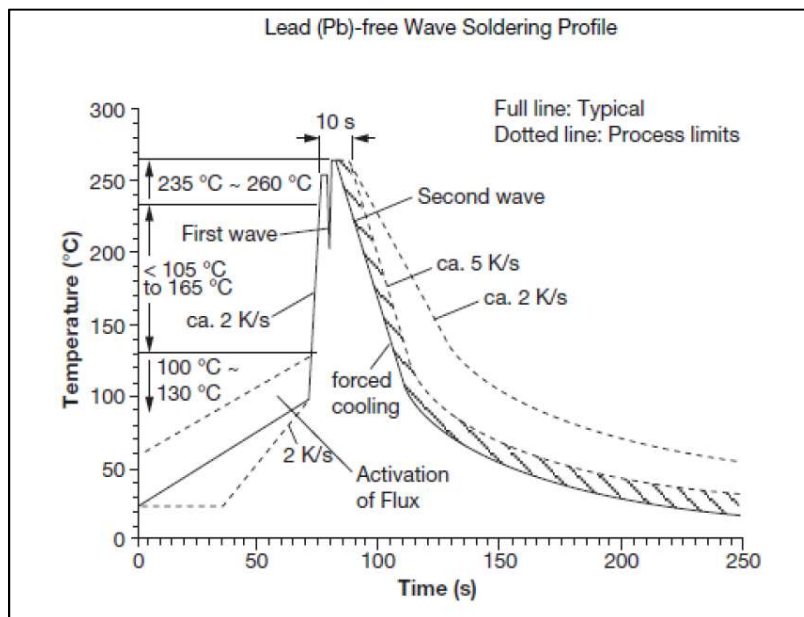
6. Environmental Characteristics

ITEM	DESCRIPTION	TEST CONDITIONS	REQUIREMENTS
6-1	Resistance Low Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: -40°C ±3°C 2)Time: 96 hours	1)As shown in item 4-3, 4-4, 5-1 2)Contact Resistance: 200mΩ max
6-2	Resistance High Temperature	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 85°C ±2°C 2)Time: 96 hours	1)As shown in item 4-3, 4-4, 5-1 2)Contact Resistance: 200mΩ max
6-3	Resistance Humidity	Following the test set forth below the sample shall be left in normal temperature and humidity conditions for an hour before measurements are made: 1)Temperature: 40°C ±2°C 2)Relative humidity: 90~95% 3)Time: 240 hours	1)As shown in item 4-4, 5-1 2)Contact Resistance: 200mΩ max 3)Insulation Resistance: 10 MΩ min

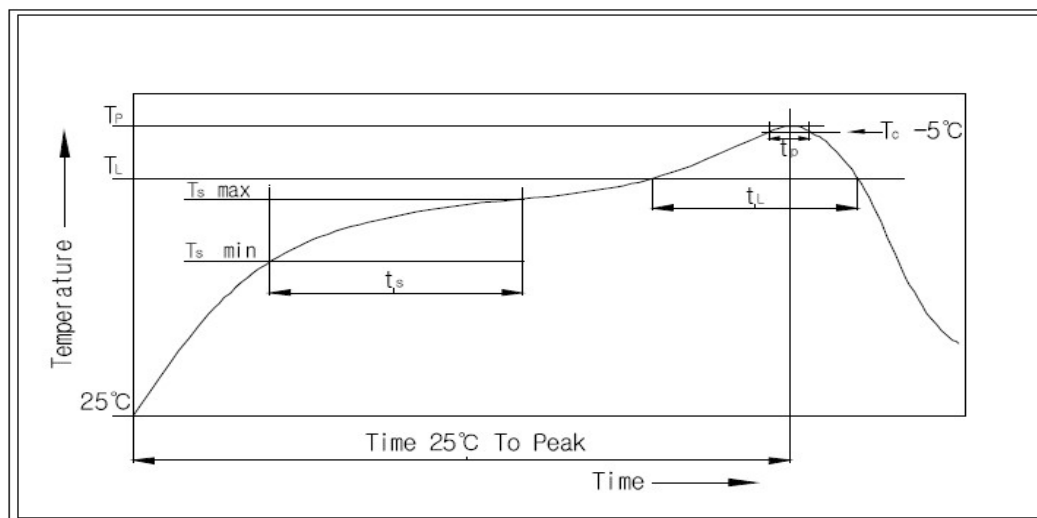
7. This item is "RoHS" Compliant

8. Manual Soldering : Max 350°C, 3 sec.

9. Wave Soldering Conditions:



10. Reflow Soldering Conditions:



10-1 Condition for Soldering

Profile Feature	Pb-Free Assembly
Average Ramp-UP Rate(Ts max to TP)	3°C/second max
Preheat - Temperature Min(Ts min) - Temperature Max(Ts max) - Time (ts min to ts max)	150°C 200°C 60-180seconds
Time maintained above: - Temperature (TL) - Time (tL)	217°C 60-150seconds
Peak/Classification Temperature(TP)	260°C +0°C/ -5°C
Time within 5°C of actual Peak Temperature(TP)	5~10 seconds
Ramp-Down Rate	6°C/sec max
Time 25°C to Peak Temperature	8 minutes max